

### ZIITEK ELECTRONIC MATERIAL & TECHNOLOGY CO.,LTD

## TIF<sup>™</sup> 700L-HM Thermally Conductive Gap Filler Pads Series

REV02



# **Features**

- » Good thermal conductivity: 6.0 W/mK
- » Naturally tacky needing no further adhesive coating
- Soft and Compressible for low stress applications
- » Available in varies thickness

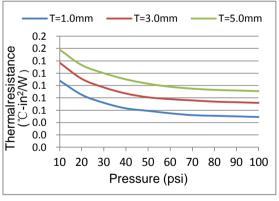
# **Application**

- Cooling components to the chassis of frame
- Set Top Box
- Car Battery & Power Supply
- » Charging Pile
- » LED TV/ Lighting

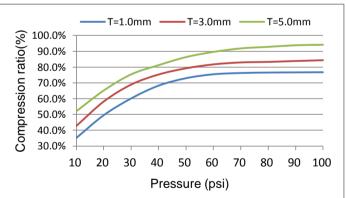
TIF<sup>TM</sup> 700L-HM Series thermally conductive interface materials are applied to fill the air gaps between the heating elements and the heat dissipation fins or the metal base. Their flexibility and elasticity make them suited to coat very uneven surfaces. Heat can transmit to the metal housing or dissipation plate from the heating elements or even the entire PCB, which effecitly enhances the efficiency and life-time of the heat-generating electronic components.

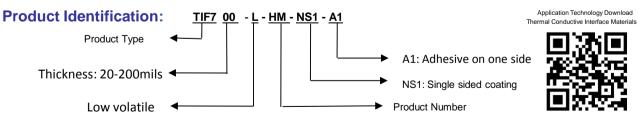
Typical Properties of TIF <sup>™</sup> 700L-HM Series		
Color	Gray	Visual
Construction	Ceramic filled silicone elastomer	******
Thickness range	0.020"(0.5mm)~0.200" (5.0mm)	ASTM D374
Hardness	30 Shore 00	ASTM 2240
Specific Gravity	3.3 g/cc	ASTM D297
Operating Temp	-40 ~160 ℃	******
Dielectric Breakdown Voltage	>5500 VAC	ASTM D149
Dielectric Constant@1MHz	4.5 MHz	ASTM D150
Volume Resistivity	1.0X10 <sup>12</sup> Ohm-cm	ASTM D257
Thermal Conductivity	6.0 W/mK	ASTM D5470
	6.0 W/mK	GB-T32064
Outgassing (TML)	0.30%	ASTM E595
Flame Rating	94 -V0	UL E331100

#### psi. vs.Thermal Resistance



# psi. vs. Compression Ratio





#### **Product Specification**

http://www.ziitek.com

**Product Thicknesses:** 0.020-inch to 0.200-inch (0.5mm to 5.0mm) **Product Sizes:** 8" x 16"(203mm x406mm) Individual die cut shapesand and custom thickness can be supplied. Please contact us for confirming

Canada:

Tel:+001-604-2998559 E-mail: sales@thermazig.com China: Tel: +86-769-38801208 E-mail: frances@ziitek.com.tw

Talwan:
Tel:+886-2-22771007
E-mail:frances@ziitek.com.tw

The information and statements herein are believed to be reliable but are not to be construed as a warranty or representation for which we assume legal responsibility. Users should undertake sufficient verification and testing to determine the suitability for their own particular purpose of any information or products referred to herein.